Hongyun So Nov 02 2022

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Research Microsystems and Microelectronics, Heat Transfer, Microfluidics Interests

Mechanical Issues in Microsystems including Heat Transfer & Fluid Mechanics

Microfabrication of Sensors, MEMS, Functional Surfaces

Education University of California, Berkeley, USA Dec 2014

Ph.D. in Mechanical Engineering

KAIST, Daejeon, Korea Feb 2011

M.S. in Mechanical Engineering

Hanyang University, Seoul, Korea Feb 2009

B.S. in Mechanical Engineering

Appointments Assistant, Associate Professor Sep 2017-

Department of Mechanical Engineering, Hanyang University

Postdoctoral Scholar Mar 2015-

Department of Aeronautics & Astronautics, Stanford University Aug 2017

Teaching Thermodynamics I & II

Advanced Thermodynamics Thermal Power Plant Engineering

Electrical Engineering, Electronic Engineering Career Development I & II, Capstone Design I & II

Technical Microfabrication

(Thin film deposition): MOCVD, PECDV, LPCVD, ALD **Skills**

(Metal deposition): sputtering, E-beam evaporation, electroplating

(Lithography): standard lithography, ASML stepper, E-beam lithography

(Dry etching): DRIE, ICP, plasma, XeF₂

(Wet etching): KOH, HF, TMAH

(Others): RTA, CPD, CMP, wire bonding, dicing